

DESCRIPTION

The MP6231/MP6232 Power Distribution Switch features internal current limiting to prevent damage to host devices due to faulty load conditions. The MP6231/MP6232 analog switch has 85mΩ on-resistance and operates from 2.7V to 5.5V input. It is available with guaranteed current limits, making it ideal for load switching applications. The MP6231/MP6232 has built-in protection for both over current and increased thermal stress. For over current, the device will limit the current by changing to a constant current mode.

As the temperature increases as a result of short circuit, then the device will shut off. The device will recover once the device temperature reduces to approx 120°C.

The MP6231/MP6232 is available in 8-pin MSOP, SOIC package with exposed pad and 8-pin SOIC w/o exposed pad.

FEATURES

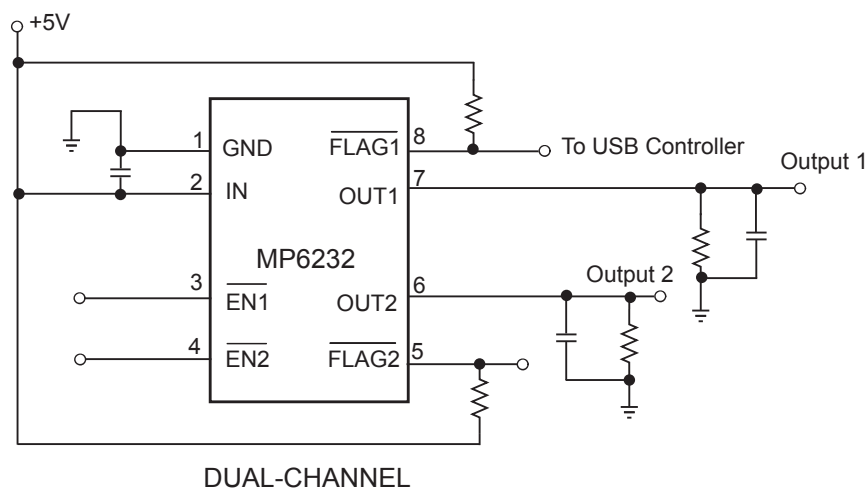
- 500mA Continuous Current
- Accurate Current Limit
- 2.7V to 5.5V Supply Range
- 140μA Quiescent Current
- 85mΩ MOSFET
- Thermal-Shutdown Protection
- Under-Voltage Lockout
- 8ms FLAG Deglitch Time
- No FLAG Glitch During Power Up
- Reverse Current Blocking
- Active High & Active Low Options
- UL File # E322138

APPLICATIONS

- Smartphone and PDA
- Portable GPS Device
- Notebook PC
- Set-top-box
- Telecom and Network Systems
- PC Card Hot Swap
- USB Power Distribution

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TYPICAL APPLICATION



UL Recognized Component

ORDERING INFORMATION

Part Number	Enable	Switch	Maximum Continuous Load Current	Typical Short-Circuit Current @ T _A =25C	Package	Top Marking	Free Air Temperature (T _A)
MP6231DN*	Active High	Dual	0.5A	750mA	SOIC8E	MP6231DN	-40°C to +85°C
MP6231DH					MSOP8E	6231D	
MP6231DS					SOIC8		
MP6232DN	Active Low				SOIC8E	MP6232DN	
MP6232DH					MSOP8E	6232D	
MP6232DS					SOIC8		

* For Tape & Reel, add suffix -Z (e.g. MP6231DN-Z).
For RoHS compliant packaging, add suffix -LF (e.g. MP6231DN-LF-Z)

PACKAGE REFERENCE

TOP VIEW MSOP8E	TOP VIEW SOIC8E	TOP VIEW SOIC8
MP6231/MP6232Dual-Channel (* EN is active high for MP6231)		

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

IN	-0.3V to +6.0V
EN, FLAG, OUT to GND	-0.3V to +6.0V
Continuous Power Dissipation (T _A = +25°C) ⁽²⁾	
SOIC8E	2.5W
MSOP8E	2.27W
SOIC8	1.4W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	-65°C to +150°C
Operating Junct. Temp.	-40°C to +125°C

Thermal Resistance ⁽³⁾

	θ _{JA}	θ _{JC}
SOIC8E	50	10... °C/W
MSOP8E	55	12... °C/W
SOIC8	90	42... °C/W

Notes:

- Exceeding these ratings may damage the device.
- The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance θ_{JA}, and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX)-T_A)/θ_{JA}. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- Measured on JESD51-7, 4-layer PCB.

ELECTRICAL CHARACTERISTICS ⁽⁴⁾

$V_{IN}=5V$, $T_A=+25^{\circ}C$, unless otherwise noted.

Parameter	Condition	Min	Typ	Max	Units
IN Voltage Range		2.7		5.5	V
Supply Current	One Channel Enabled, $I_{OUT}=0$, One Switch ON		90	120	μA
Supply Current	Both Channels Enabled, $I_{OUT}=0$, Both Switches ON		140	160	μA
Shutdown Current	Device Disable, $V_{OUT}=float$, $V_{IN}=5.5V$		1		μA
Off Switch Leakage	Device Disable, $V_{IN}=5.5V$		1		μA
Current Limit		550		1100	mA
Trip Current	Current Ramp (slew rate $\leq 100A/s$) on Output		1.2	1.6	A
Under-voltage Lockout	Rising Edge	1.95		2.65	V
Under-voltage Hysteresis			250		mV
FET On Resistance	$I_{OUT}=100mA$, and $-40^{\circ}C < T_A < 85^{\circ}C$		85	130	m Ω
EN Input Logic High Voltage		2			V
EN Input Logic Low Voltage				0.8	V
FLAG Output Logic Low Voltage	$I_{SINK}=5mA$			0.4	V
FLAG Output High Leakage Current	$V_{IN}=V_{FLAG}=5.5V$			1	μA
Thermal Shutdown			140		$^{\circ}C$
Thermal Shutdown Hysteresis			20		$^{\circ}C$
V_{OUT} Rising Time, T_r	$V_{IN}=5.5V$, $C_L=1\mu F$, $R_L=11\Omega$		0.9		ms
	$V_{IN}=2.7V$, $C_L=1\mu F$, $R_L=11\Omega$		1.7		ms
V_{OUT} Falling Time, T_f	$V_{IN}=5.5V$, $C_L=1\mu F$, $R_L=11\Omega$			0.5	ms
	$V_{IN}=2.7V$, $C_L=1\mu F$, $R_L=11\Omega$			0.5	ms
Turn On Time, T_{on}	$C_L=100\mu F$, $R_L=11\Omega$			3	ms
Turn Off Time, T_{off}	$C_L=100\mu F$, $R_L=11\Omega$			10	ms
FLAG Deglitch Time		4	8	15	ms
ENx Input Leakage			1		μA
Reverse Leakage Current	$OUTX=5.5V$, $IN=GND$		0.2		μA

Notes:

4) Production test at $+25^{\circ}C$. Specifications over the temperature range are guaranteed by design and characterization.

PIN FUNCTIONS

MP6231/MP6232

SOIC8 SOIC8E MSOP8E	Name	Description
1	GND	Ground.
2	IN	Input Voltage. Accepts 2.7V to 5.5V input.
3	$\overline{\text{EN1}}$	Active Low: (MP6232), Active High: (MP6231)
4	$\overline{\text{EN2}}$	Active Low: (MP6232), Active High: (MP6231)
5	$\overline{\text{FLAG2}}$	IN-to-OUT2 Over-current, active-low output flag. Open-Drain.
6	OUT2	IN-to-OUT2 Power-Distribution Switch Output.
7	OUT1	IN-to-OUT1 Power-Distribution Switch Output
8	$\overline{\text{FLAG1}}$	IN-to-OUT1 Over-current, active-low output flag. Open-Drain.

TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = +25^\circ\text{C}$, unless otherwise noted.

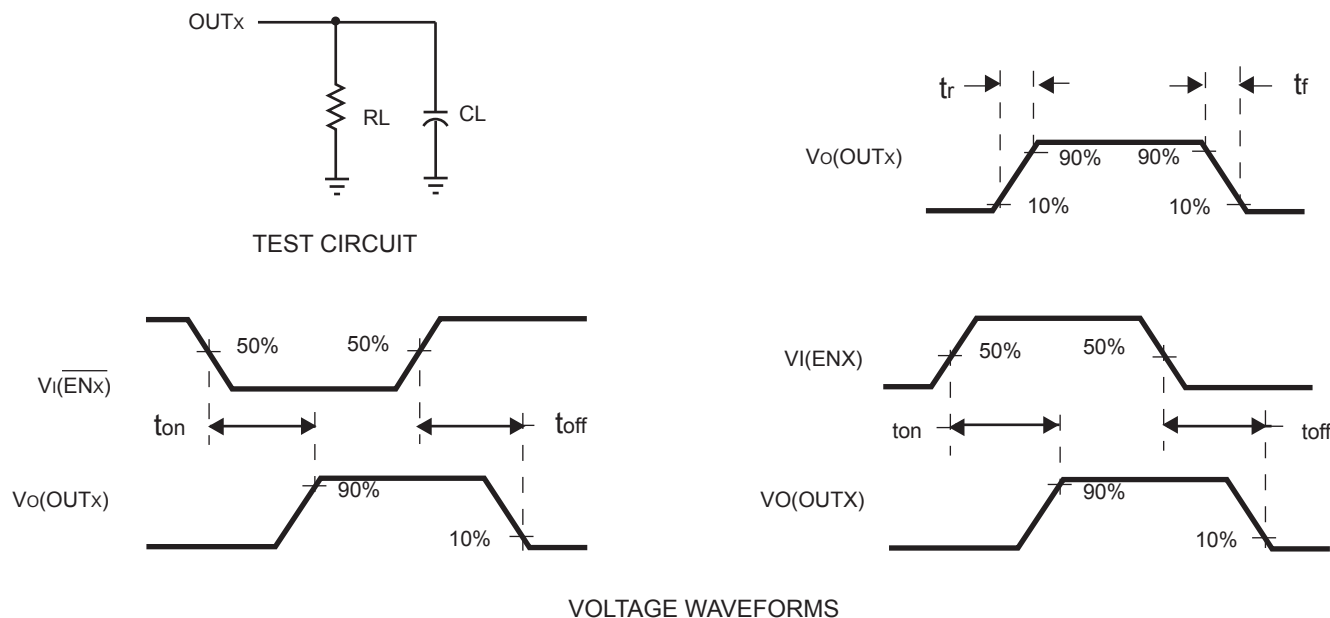


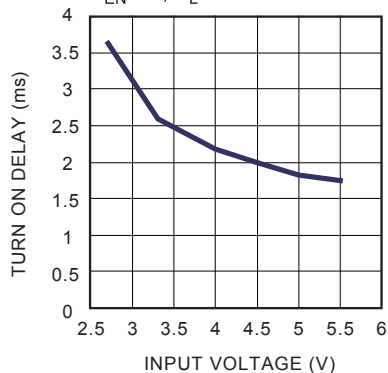
Figure 1—Test Circuit and Voltage Waveforms

TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN}=5.5V$, $C_L = 1\mu F$, $T_A = +25^\circ C$, unless otherwise noted.

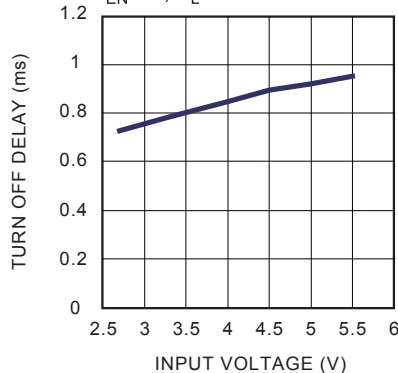
Turn on Delay vs. Input Voltage

$V_{EN}=5V$, $R_L=11\Omega$



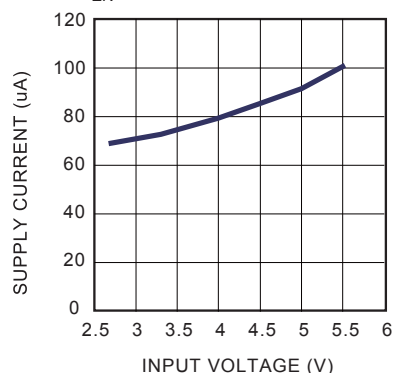
Turn off Delay vs. Input Voltage

$V_{EN}=5V$, $R_L=11\Omega$



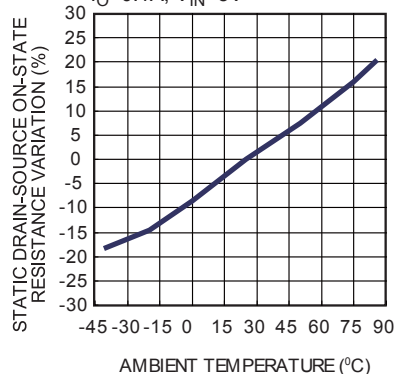
Supply Current, Output Enabled vs. Input Voltage

$V_{EN}=5V$



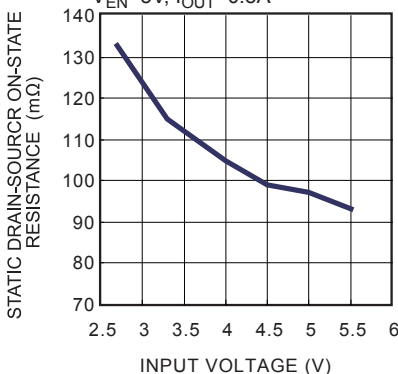
Static Drain-Source On-State Resistance Variation vs. Ambient Temperature

$I_O=0.1A$, $V_{IN}=5V$



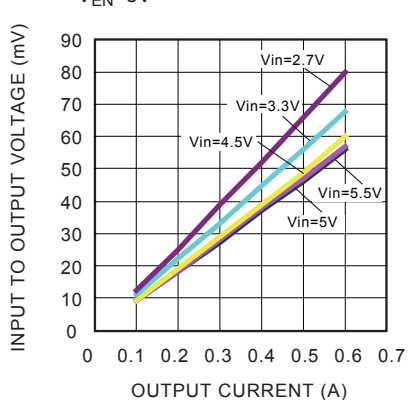
Static Drain-Source On-State Resistance vs. Input Voltage

$V_{EN}=5V$, $I_{OUT}=0.5A$



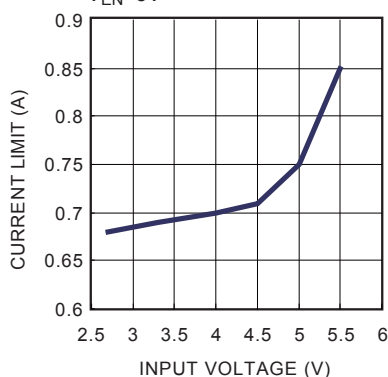
Input to Output Voltage vs. Load Current

$V_{EN}=5V$



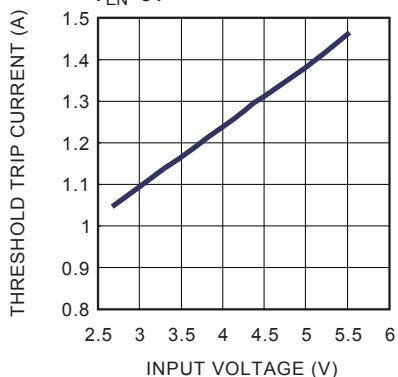
Current Limit vs. Input Voltage

$V_{EN}=5V$



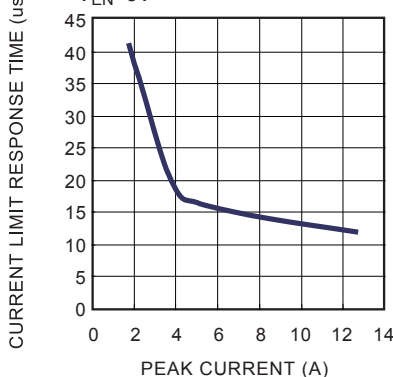
Threshold Trip Current vs. Input Voltage

$V_{EN}=5V$



Current Limit Response Time vs. Peak Current

$V_{EN}=5V$

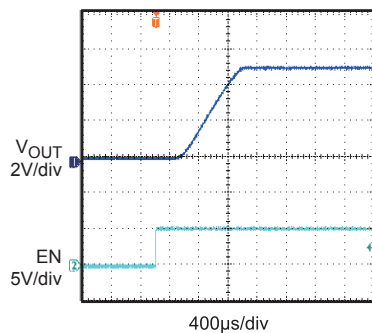


TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN}=5.5V$, $C_L = 1\mu F$, $T_A = +25^\circ C$, unless otherwise noted.

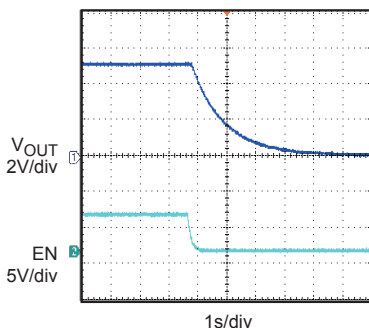
Turn On Delay and Rise Time with 0.1 μF Load

$V_{EN}=5V$, $C_L=0.1\mu F$



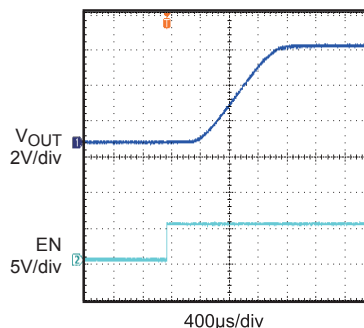
Turn Off Delay and Fall Time with 0.1 μF Load

$V_{EN}=5V$, $C_L=0.1\mu F$



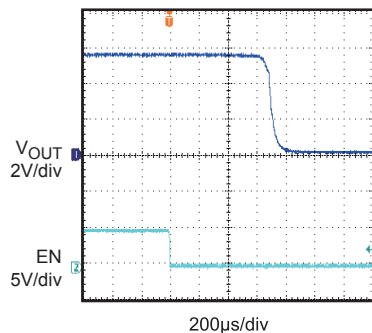
Turn On Delay and Rise Time with 1 μF Load

$V_{EN}=5V$, $R_L=11\Omega$, $C_L=1\mu F$



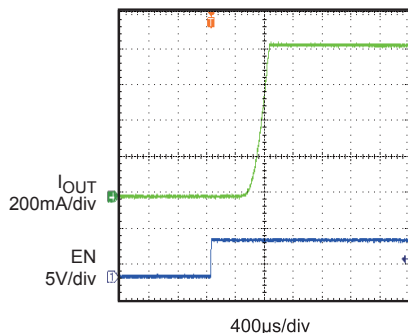
Turn Off Delay and Fall Time with 1 μF Load

$V_{EN}=5V$, $R_L=11\Omega$, $C_L=1\mu F$



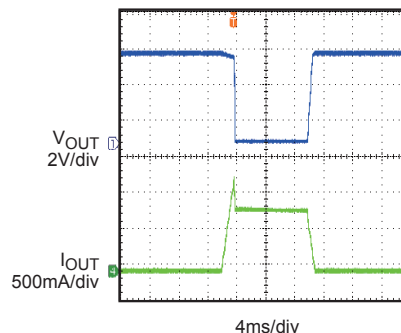
Short Circuit Current Device Enabled into Short

$V_{EN}=5V$, $C_L=1\mu F$



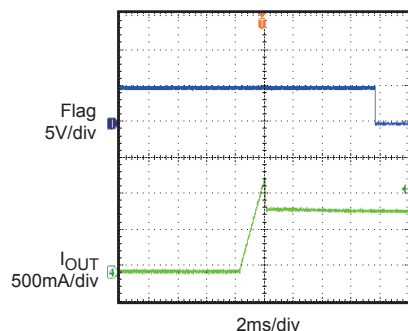
Threshold Trip Current with Ramped Load on Enabled Device

$V_{EN}=5V$, $C_L=1\mu F$



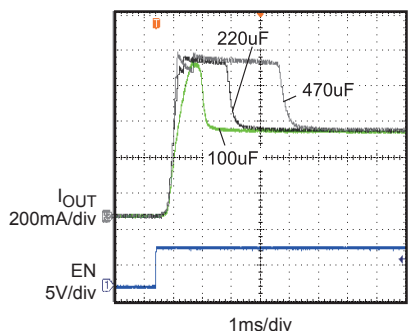
Ramped Load on Enabled Device

$V_{EN}=5V$, $C_L=1\mu F$



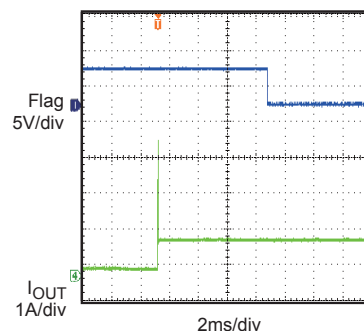
Inrush Current with Different Load Capacitance

$V_{EN}=5V$, $R_L=11\Omega$,
Start up by EN



1 Ω Load Connected to Enabled Device

$V_{EN}=5V$, $C_L=1\mu F$



FUNCTION BLOCK DIAGRAM

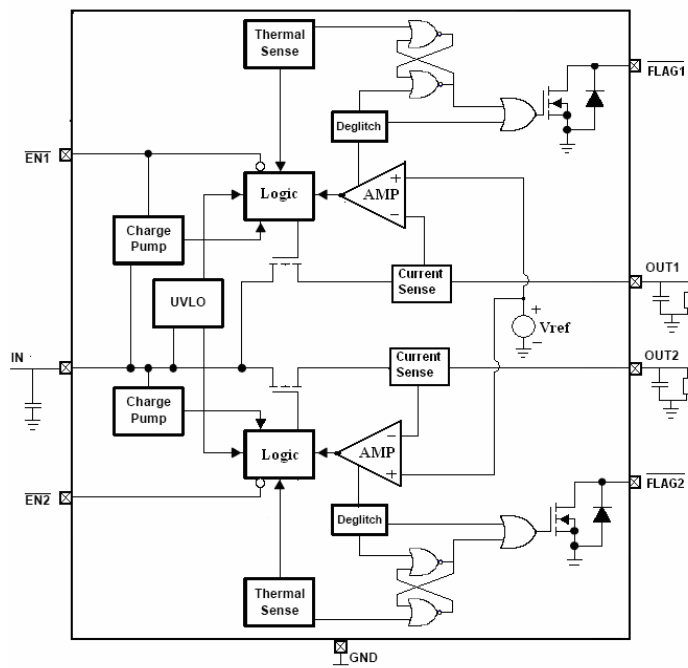


Figure 2—Functional Block Diagram

DETAILED DESCRIPTION

Over Current

When the load exceeds trip current (minimum threshold current triggering constant-current mode) or a short is present, MP6231/MP6232 switches into to a constant-current mode (current limit value). MP6231/MP6232 will be shutdown only if the overcurrent condition stays long enough to trigger thermal protection.

Trigger overcurrent protection for different overload conditions occurring in applications:

- 1) The output has been shorted or overloaded before the device is enabled or input applied. MP6231/MP6232 detects the short or overload and immediately switches into a constant-current mode.
- 2) A short or an overload occurs after the device is enabled. After the current-limit circuit has been tripped (reached the trip current threshold), the device switches into constant-current mode. However, high current may flow for a short period of time before the current-limit circuit can react.

- 3) Output current has been gradually increased beyond the recommended operating current. The load current rises until the trip current threshold is reached or until the thermal limit of the device is exceeded. The MP6231/MP6232 is capable of delivering current up to the trip current threshold without damaging the device. Once the trip threshold has been reached, the device switches into its constant-current mode.

Flag Response

The FLAG pin is an open drain configuration. This FAULT will report a fail mode after an 8ms deglitch timeout. This is used to ensure that no false fault signals are reported. This internal deglitch circuit eliminates the need for extend components. The FLAG pin is not deglitched during an over temp. or a voltage lockout.

Thermal Protection

The purpose of thermal protection is to prevent damage in the IC by allowing excessive current to flow and heating the junction. The die temp. is internally monitored until the thermal limit is reached. Once this temp. is reached, the switch will turn off and allow the chip to cool. The switch has a built-in hysteresis.

Under-voltage Lockout (UVLO)

This circuit is used to monitor the input voltage to ensure that the MP6231/MP6232 is operating correctly. This UVLO circuit also ensures that there is no operation until the input voltage reaches the minimum spec.

Enable

The logic pin disables the chip to reduce the supply current. The device will operate once the enable signal reaches the appropriate level. The input is compatible with both COMS and TTL.

APPLICATION INFORMATION

Power-Supply Considerations

Over 10 μ F capacitor between IN and GND is recommended. This precaution reduces power-supply transients that may cause ringing on the input and improves the immunity of the device to short-circuit transients.

In order to achieve smaller output load transient, placing a high-value electrolytic capacitor on the output pin(s) is recommended when the output load is heavy.

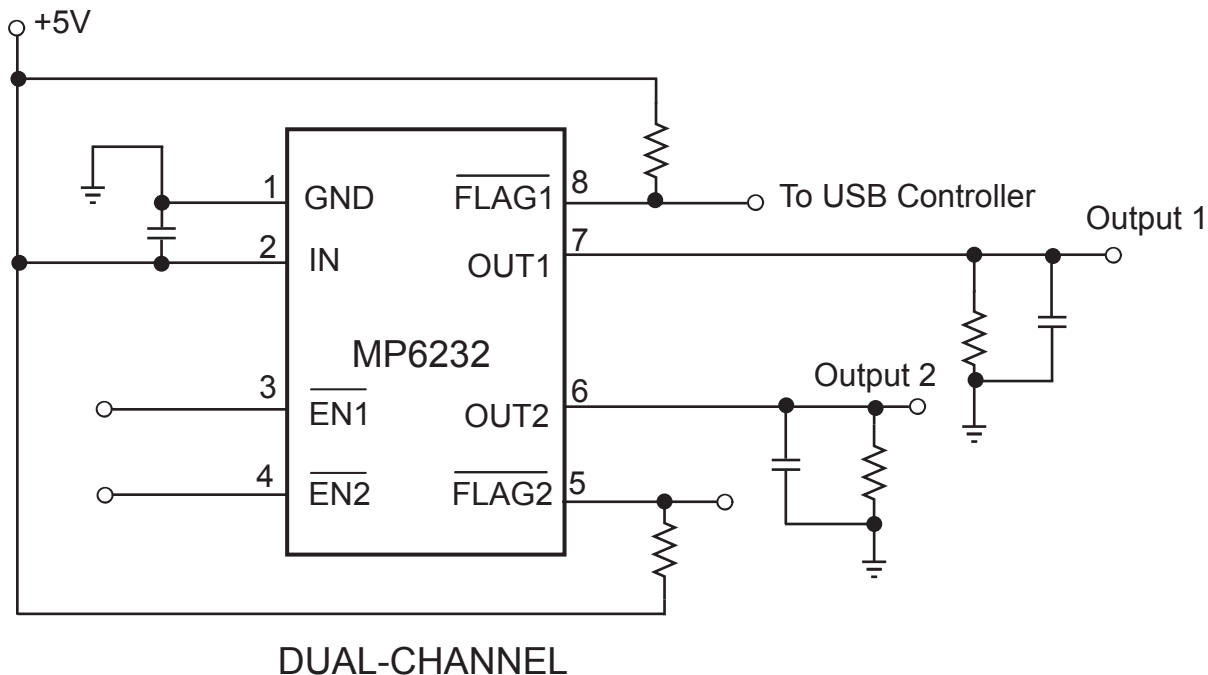
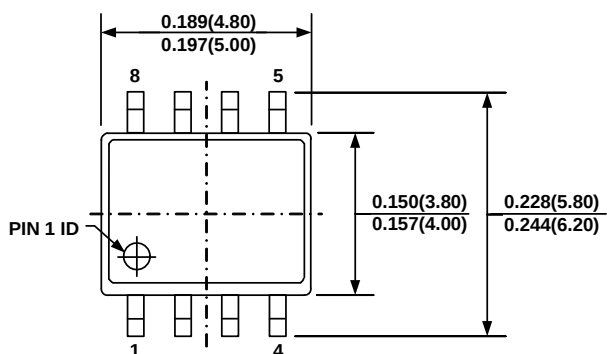


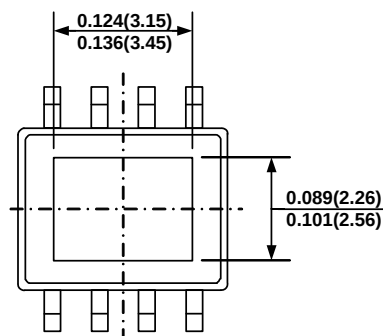
Figure 3—Application Circuit

PACKAGE INFORMATION

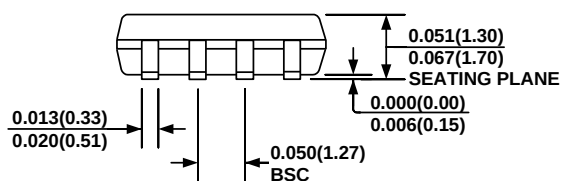
SOIC8E



TOP VIEW

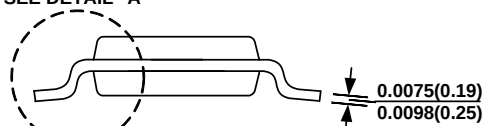


BOTTOM VIEW

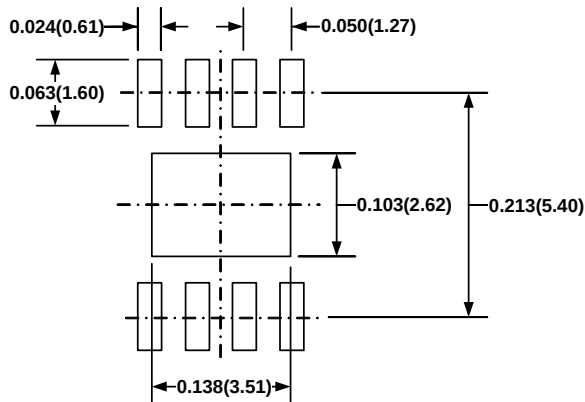


FRONT VIEW

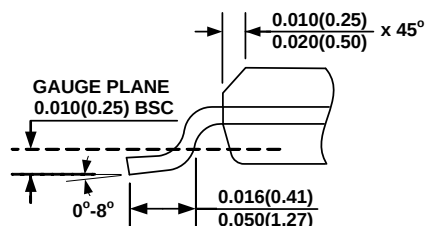
SEE DETAIL "A"



SIDE VIEW



RECOMMENDED LAND PATTERN

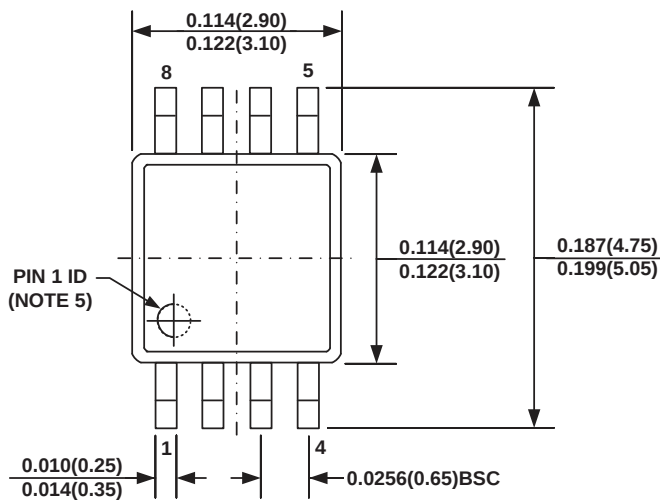


DETAIL "A"

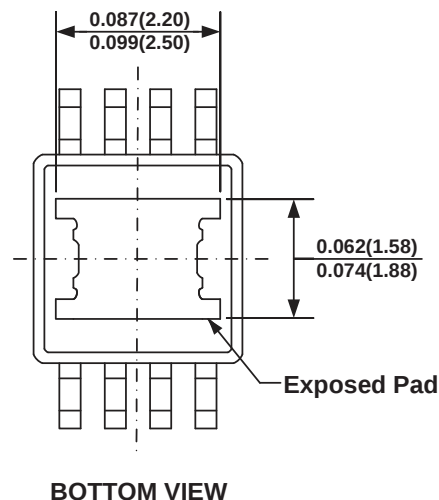
NOTE:

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION BA.
- 6) DRAWING IS NOT TO SCALE.

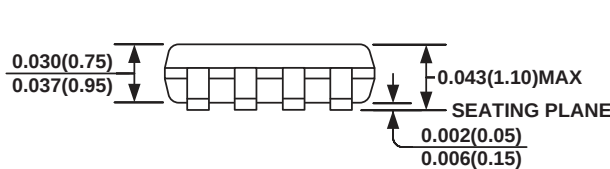
MSOP8E (EXPOSED PAD)



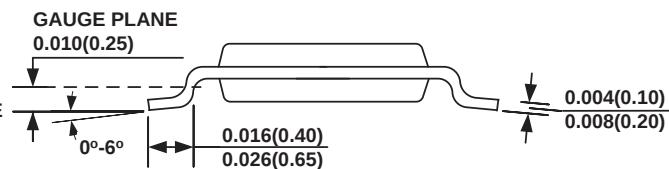
TOP VIEW



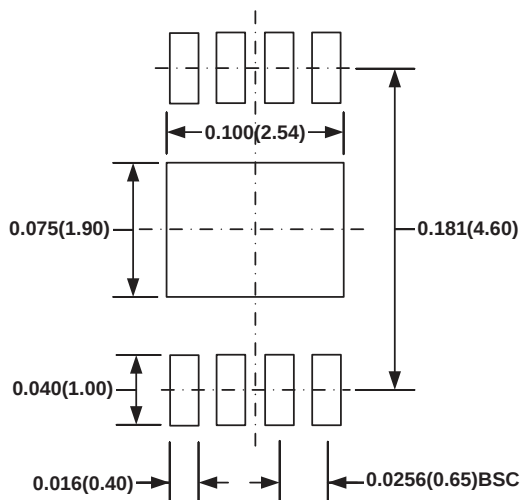
BOTTOM VIEW



FRONT VIEW



SIDE VIEW

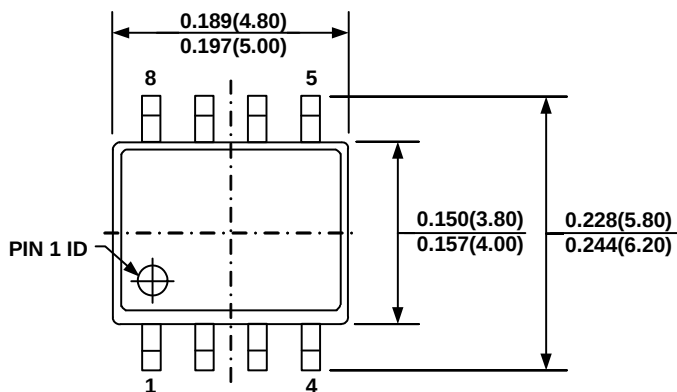


RECOMMENDED LAND PATTERN

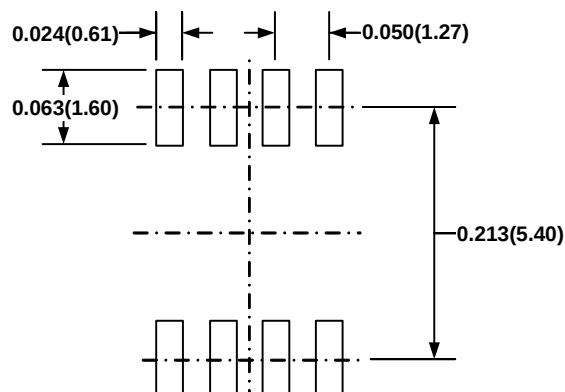
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- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) PIN 1 IDENTIFICATION HAS HALF OR FULL CIRCLE OPTION.
- 6) DRAWING MEETS JEDEC MO-187, VARIATION AA-T.
- 7) DRAWING IS NOT TO SCALE.

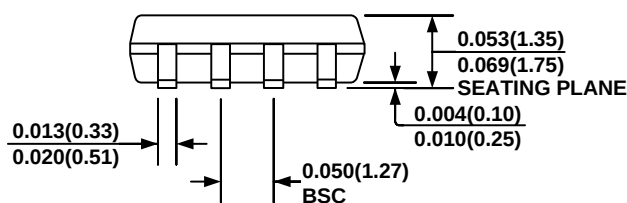
SOIC8



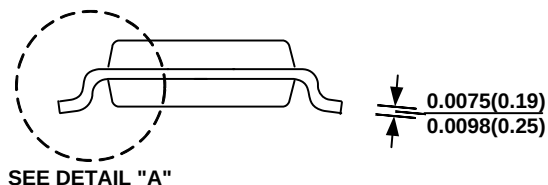
TOP VIEW



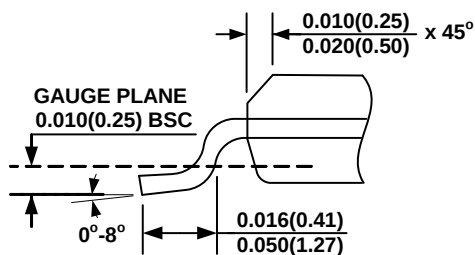
RECOMMENDED LAND PATTERN



FRONT VIEW



SIDE VIEW



DETAIL "A"

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- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

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Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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